

## BUK436-60A-VB Datasheet N-Channel 60 V (D-S) MOSFET

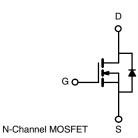
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	60				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.007				
I <sub>D</sub> (A)	150				
Configuration	Single				
Package	TO-247				

#### FEATURES

- Trench power MOSFET
- Package with low thermal resistance
- 100 %  $\rm R_g$  and UIS tested







ABSOLUTE MAXIMUM RATING	<b>iS</b> (T <sub>C</sub> = 25 °C, unles	s otherwise noted	)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V <sub>DS</sub>	60	V		
Gate-Source Voltage	V <sub>GS</sub>	± 20	V		
Continuous Drain Current	T <sub>C</sub> = 25 °C	1	150		
Continuous Drain Current	T <sub>C</sub> = 125 °C	I <sub>D</sub>	88		
Continuous Source Current (Diode Conduct	۱ <sub>S</sub>	120	А		
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	480			
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	65		
Single Pulse Avalanche Energy	L = 0.1 MH	E <sub>AS</sub>	211	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	Р	175	W	
Maximum Fower Dissipation -	T <sub>C</sub> = 125 °C	P <sub>D</sub>	56	vv	
Operating Junction and Storage Temperatu	re Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS								
PARAMETER		SYMBOL	LIMIT	UNIT				
Junction-to-Ambient	PCB Mount <sup>c</sup> R <sub>thJA</sub>		40	°C/W				
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.88	0/11				

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT		
Static					•	•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0, I <sub>D</sub> = 250 μA	60	-	-	v	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.5	3.0	3.5	v	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	0 V, $V_{GS}$ = ± 20 V	-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 125 °C	-	-	50	μA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 175 °C	-	-	250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	120	-	-	Α	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A	-	0.007	-		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C	-	0.010	-	Ω	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C	-	0.013	-		
Forward Transconductance b	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A		-	94	-	S	
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>			-	5196	-		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 25 V, f = 1 MHz	-	710	-	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	1		-	340	-		
Total Gate Charge <sup>c</sup>	Qg			-	97	-		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$	$V_{DS} = 30 \text{ V}, I_D = 75 \text{ A}$	-	24.6	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>	1		-	27.2	-		
Gate Resistance	Rg	f = 1 MHz		0.3	1	1.7	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	16	24		
Rise Time <sup>c</sup>	t <sub>r</sub>	$\label{eq:V_DD} \begin{array}{l} V_{\text{DD}} = 30 \text{ V}, \ R_{\text{L}} = 0.4 \ \Omega \\ I_{\text{D}} \cong 75 \text{ A}, \ V_{\text{GEN}} = 10 \text{ V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$		-	14	21	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	34	51		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	9	14		
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>	·						
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	480	Α	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = 75 A, V <sub>GS</sub> = 0		-	0.9	1.5	V	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

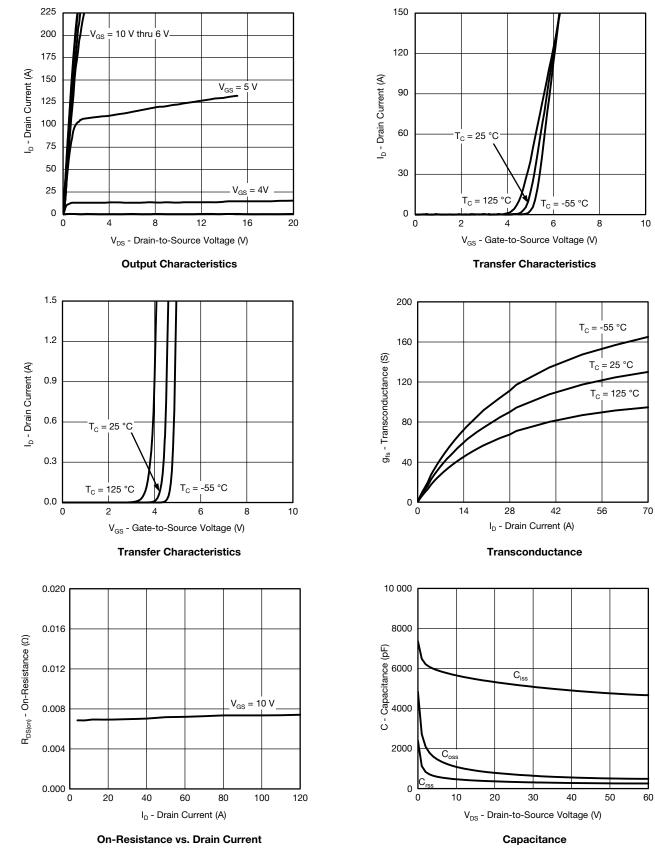
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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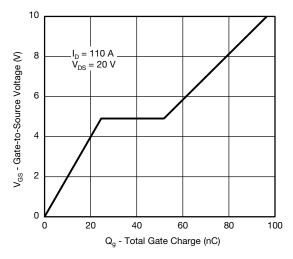
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



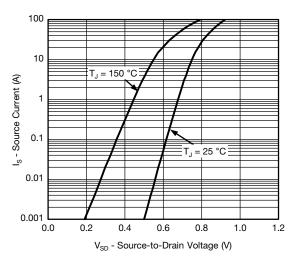
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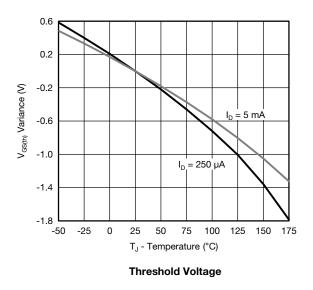
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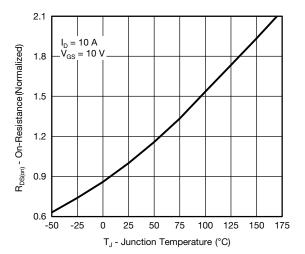


Gate Charge

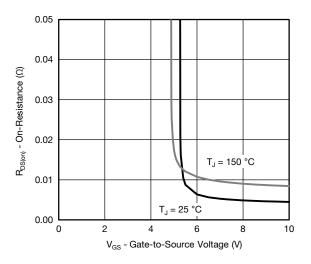


Source Drain Diode Forward Voltage

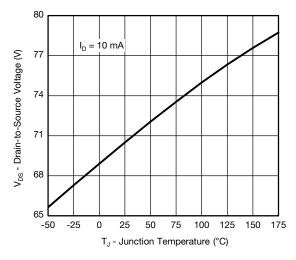


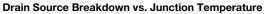


**On-Resistance vs. Junction Temperature** 



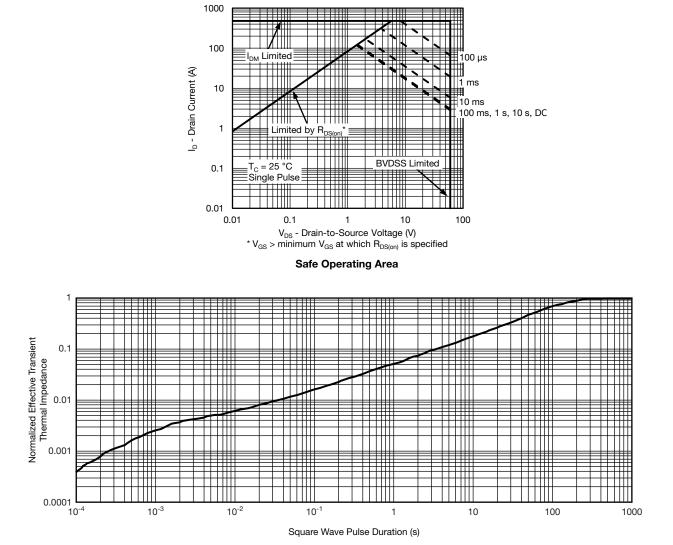
On-Resistance vs. Gate-to-Source Voltage







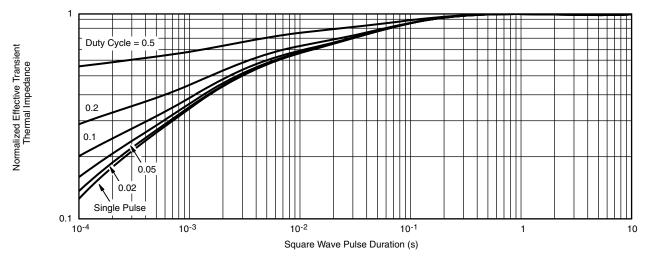
#### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

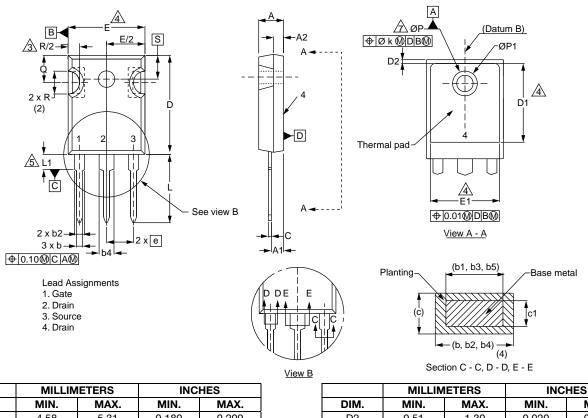
#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



**TO-247AC** 



	MILLIMETERS		INCHES			IVILLIN	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.58	5.31	0.180	0.209	D2	0.51	1.30	0.020	0.051	
A1	2.21	2.59	0.087	0.102	E	15.29	15.87	0.602	0.625	
A2	1.17	2.49	0.046	0.098	E1	13.72	-	0.540	-	
b	0.99	1.40	0.039	0.055	е	5.46	5.46 BSC		0.215 BSC	
b1	0.99	1.35	0.039	0.053	Øk	0.2	0.254		0.010	
b2	1.53	2.39	0.060	0.094	L	14.20	16.25	0.559	0.640	
b3	1.65	2.37	0.065	0.093	L1	3.71	4.29	0.146	0.169	
b4	2.42	3.43	0.095	0.135	N	7.62	7.62 BSC		0.300 BSC	
b5	2.59	3.38	0.102	0.133	ØP	3.51	3.66	0.138	0.144	
С	0.38	0.86	0.015	0.034	Ø P1	-	7.39	-	0.291	
c1	0.38	0.76	0.015	0.030	Q	5.31	5.69	0.209	0.224	
D	19.71	20.82	0.776	0.820	R	4.52	5.49	0.178	0.216	
D1	13.08	-	0.515	-	S	5.51	5.51 BSC		0.217 BSC	



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